Numerical Simulation of Dynamic Wetting Behavior in the Wetting Balance Method

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Wetting balance test is known to be the most versatile method to evaluate wettability during soldering process, because it provides quantitative information and time dependent wetting behavior. There are many other studies exist related with the wetting force, however, as to wetting time, there are few theoretical backgrounds and mathematical analysis. In this study, the wetting time is focused on a wettability index. The wetting curve, which shows time dependant wetting behavior, is predicted by using computer simulation and compared with oil experiment also, the mechanism of meniscus rise is analyzed. As a result, relationship of calculated and measured wetting curve can be obtained. It is found that the viscosity of a liquid is the major variable that determine the wetting time and wetting rate.

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1. Introduction

Input/output (I/O) requirements for integrated circuit (IC) packages continue to increase with increasing levels of circuit integration, while the package size continues to decrease. Most of interconnections of the package are based on soldering process-joining between Sn based solder materials and Cu(or Ni) substrate. This interconnection process, however, has several problems: toxicity and radioactivity of lead as a solder alloy element, corrosion of substrate by using flux cleaning agents and excessive growth of Sn–Cu intermetallic compound.¹–³ Thus, new solder materials and soldering process are required to address the above problems and the solderability becomes a critical property for both developing new solder materials and soldering processes.

Wetting balance method has been known to be the most versatile method to evaluate solderability, because it provides quantitative information and time dependent wetting behavior.⁴–⁶) By using wetting balance method a wetting balance quantitative information and time dependent wetting behavior. There are many other studies exist related with the wetting force, however, as to wetting time, there are few theoretical backgrounds and mathematical analysis. In this study, the wetting time is focused on a wettability index. The wetting curve, which shows time dependant wetting behavior, is predicted by using computer simulation and compared with oil experiment also, the mechanism of meniscus rise is analyzed. As a result, relationship of calculated and measured wetting curve can be obtained. It is found that the viscosity of a liquid is the major variable that determine the wetting time and wetting rate.

2. Theoretical Background

2.1 Force balance equation

In general Young’s equation can be applied to the interface between substrate and solder.

$$\gamma_{SV} - \gamma_{LS} = \gamma_{LV} \cos \theta$$  (1)

where, $\gamma_{SV}$, $\gamma_{LS}$ and $\gamma_{LV}$ are surface tension(or interfacial tension) between the substrate and vapor, between liquid solder and the substrate, and between liquid solder and vapor, respectively. $\theta$ is an contact angle at the triple point. Then, a contact angle is determined by the surface tension.

The equilibrium wetting force ($F_{eq}$) can be expressed as follows:

$$F_{eq} = mg - F_b = P \gamma \cos \theta - \rho g V_{lm}$$  (2)

where, $m$ is mass of solder rise, $g$ is gravity constant, $F_b$ is the buoyancy force, $P$ is periphery of specimen, $\rho$ is density of a solder, and $V_{lm}$ is volume of the sample immersed into the solder.

2.2 Governing equations for calculating fluid flow

The following governing transport equations need to be solved. The equations are based on the conservation of total mass and momentum. Mass continuity and momentum equations are shown in eqs. (3) and (4), respectively.

$$\frac{\partial \rho}{\partial t} + \nabla \cdot (\rho \mathbf{V}) = 0$$  (3)

$$\rho \frac{\partial \mathbf{V}}{\partial t} = \rho g - \nabla p + \nabla \cdot \mathbf{\tau}$$  (4)

where, $\rho$ is a density of fluid, $\nabla$ is a vector-gradient operator, $V$ is a velocity-vector field, $g$ is a gravity force, $p$ is a pressure.
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In order to treat fluid interface like free surface in this system, a volume of fluid (VOF) function is used. This function represents the volume of fluid per unit volume and satisfies the equation

$$\frac{\partial F}{\partial t} + u \frac{\partial F}{\partial x} + v \frac{\partial F}{\partial y} = 0$$  \hspace{1cm} (5)

where, $F$ is the volume fraction occupied by the fluid, $u$ and $v$ are the velocity components in the $x$ and $y$ directions, respectively.

The interpretation of $F$ depends on the type of problem being solved. In wetting balance system a single fluid with a free surface, $F$ represents the volume fraction occupied by the fluid. Thus fluid exists where $F = 1$ and void regions correspond to locations where $F = 0$. Physically, void represent regions filled with a gas whose density is insignificant with respect to the fluid density.

In laminar flow condition the wall shear stress is obtained from the equation below;

$$\tau_w = \mu \frac{u_p}{\delta y}$$  \hspace{1cm} (6)

where, $\mu$ is the dynamic viscosity of fluid, $u_p$ is the fluid velocity adjacent to the wall and $\delta y$ is the distance from the wall.

This formula was based on the assumption that the velocity varies linearly with distance from the wall in a laminar flow.

The solutions of the transport, turbulent and volume of fluid function equations were obtained using the commercial code FLOW-3D. The calculations were made in a transient-solution mode. All the computations were performed on a PC with P-II 500 MHz. With a two-dimensional grid containing 12000 cells ($X \times Y = 150 \times 80$) in cartesian coordinate system as shown in Fig. 1, a typical simulation took about 24 hours of CPU time.

3. Experimental Procedure

Wetting balance tests were performed with SAT-5000 as shown in Fig. 2. Computer control of the wetting balance; acquisition and analysis of data were performed using wetting tester software by Rhesca Co.

For the oil experiments on Cu plate, silicon oil from Shin-Etsu Chemical was used. The nominal properties at 25°C from the manufacturer are: kinematic viscosity of 0.50 cm²/s ($\mu = 0.48$ g/cm s), density of 0.963 g/cm³, and surface tension of 0.00208 J/m². Experiments were made on 99.99% pure Cu plate. The Cu plates were 10 mm wide, 0.15 mm thick, and 15 mm high.

Experiments were conducted with the oil bath at room temperature. Before immersion in oil, the plates were cleaned with acetone and alcohol. For the wetting balance tests the immersion speed was set at 1 mm/s and the immersion depth was 0.1 mm.

4. Results and Discussion

4.1 Comparison of oil experiment with computer simulation

Figure 3 showed the comparison of experimental and calculated results of wetting balance curves using silicon oil. The immersion depth was set at 0 mm and the bath was withdrawn in 2 seconds. A contact angle was set at 17.5°.

It was seen from Fig. 3 that the calculated result was matched well with the measurement from the beginning of
the curve to the level of the equilibrium wetting force. Both the wetting rate, the time to reach an equilibrium state and the equilibrium wetting force showed in good agreements. From these results, it was found that the wetting behavior of silicon oil could be predicted based on the analysis of transport phenomena of the fluid. But the calculated wetting curve during withdrawal stage showed large deviations from the measured one. The moment of detachment of the oil from the specimen (when a maximum withdrawal force is measured) was delayed approximately by 1 second compared to the measurement. This will be explained later.

In order to compare the calculated results with the measurement, measured values of the wetting force, the wetting rate and the wetting time were summarized in Table 1. The last row in the table showed the difference in percent error of the calculated wetting indices to the measured one. There were very limited differences in percent error of the equilibrium force (F<sub>eq</sub>), wetting rate, two thirds of wetting force (F<sub>2/3</sub>), the time to reach two thirds of wetting force (t<sub>2/3</sub>) and maximum withdrawal force (F<sub>wd</sub>). But the maximum withdrawal time was calculated to be double the measured value. While an initial wetting behavior of the wetting balance curve was quite similar to each other, a large deviation in the withdrawal stage was shown. The reason for this deviation could be explained as follows: during withdrawal oil slides down on the vertical specimen, in this case already oily surface must have an influence upon the measured withdrawal speed of the meniscus. However, in the calculation the withdrawal speed of meniscus could be delayed by bare surface of the specimen. Regarding the maximum withdrawal force less than 4% error was shown and it might not affect on the analysis of the wetting curve. However, further works have to be done on the behavior of wetting time during withdrawal.

Figure 4(a) showed the sequential shape changes of the meniscus from the start of wetting to the moment of 0.5 second. As shown in this figure, a contact angle between the oil and the specimen decreases sharply from 90 to 17.5° (the time to reach an equilibrium state) and from these results, it was possible to explain that the driving force of wetting was balancing the force at the point of contact angle in equilibrium. Figure 4(b) also showed sequential shape changes of the meniscus during withdrawal. As mentioned before, the wetting balance curve during withdrawal showed a large deviation compared to the measurement and thereby it was difficult to say that the shape change of the meniscus was perfectly simulated. However, from the similar values of the maximum wetting forces by calculations to the measurement, it is expected that the shape change of the meniscus is more or less reasonable. From Fig. 4(b), during oil sliding a contact angle decreased very slowly. But when oil comes to meet the bottom edge of the specimen, a contact angle sharply fell down to zero and moved to the bottom side of the specimen. This was similar to the mechanism during withdrawal proposed by Park et al.13, 14

Figure 5 also showed the behavior of the oil remaining on the specimen after the oil detachment. The shape of detached oil (a) changed into sphere type (b → c), followed by a spreading up the specimen (d → f) and finally it formed a thin film on the specimen. These movements caused a weight change of the specimen and then it appeared as fluctuations at the end of the calculated wetting balance curve.

### 4.2 Effects of oil viscosity

Figures 6(a) and (b) showed wetting time and force variations caused by the change in oil viscosity. Since a viscosity is the unique property of the particular liquid, it has a unique certain value of a liquid at a given temperature. The meaning of a change of viscosity in the calculation is to use a different liquid in the measurement. In other words, the test should be conducted with different temperature conditions, contact angles and densities, etc. Practically, it was impossible to change a viscosity of a certain liquid while maintaining all other conditions the same. In this study, however, all other physical properties were assumed to remain the same in order to investigate the pure effect of the viscosity variation on the wetting curve. For the calculations, dynamic viscosities were changed in the range from 0.0048 Pa·s, 0.048 Pa·s and 0.48 Pa·s.

Figure 6(a) showed a change of the equilibrium wetting force according to the wetting time. As seen, the beginning part of the wetting balance curve showed a high amplitude at a low viscosity level (μ = 0.0048 Pa·s), whereas those became smoother with increased viscosities. The high amplitude of the wetting curve was caused by the fluctuation of oil surface during withdrawal. In other words, the oil’s shaking triggered by oil rise translated into the steep curve of the
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fluctuation. But such a rapid curve change disappeared as the viscosity increased. There were no notable changes in equilibrium wetting force by the change of the viscosity but the wetting rates were very different. For example, it was found that the wetting balance curve reached the equilibrium very slowly when the viscosity is 0.48 Pa·s. As shown in Fig. 6(b), there were little changes in equilibrium wetting force and 2/3 wetting force, that is, calculated results were similar to the actual measurements.

In the calculation we made so far, the two other variables, surface tension of the liquid and contact angle, which could have an influence upon the wettability, were kept the same. Accordingly, the equilibrium wetting forces remained almost unchanged under different viscosity values. On the contrary, the wetting speed was very sensitive to the viscosity. The calculated value was similar to the actually measured one at 0.0048 Pa·s and 0.048 Pa·s. In other words, wetting time was significantly affected by liquid viscosity.

Therefore, it could be inferred from the calculated results that viscosity was one of the dominant variable affecting wetting time in case that equilibrium wetting force was the same. Finally, during testing a wettability of a certain liquid, if several experiments yielded almost similar equilibrium wetting force with different wetting rate or wetting time, we can reason the difference could be caused by the difference of the liquid viscosity.

5. Conclusion

So far, we have discussed how to evaluate wettability using wetting balance method. The paper was focused on the wetting time using silicon oil to delete complicated conditions, such as heat transfer, interfacial reaction and surface conditions. Oil meniscus during wetting balance test was simulated and the results were translated into conventional wetting curves. A good agreement between measured and calculated wetting curve was obtained. From these, it could be said that the main driving force for liquid rise on the sample was the contact angle. And from the result of viscosity effect on the wetting curve it was found that wetting time was dependent on the viscosity of the liquid. Therefore, it could be inferred from the calculated results that viscosity was one of the possible dominant variable affecting the wettability.

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